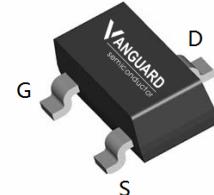


Features

- N-Channel
- Enhancement mode
- Very low on-resistance $R_{DS(on)}$ @ $V_{GS}=4.5$ V
- Fast Switching
- High Effective
- Pb-free lead plating; RoHS compliant; Hg-Free

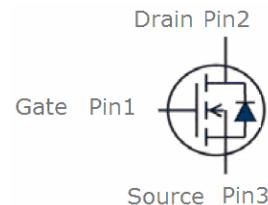
V_{DS}	40	V
$R_{DS(on),TYP} @ V_{GS}=10$ V	36	$\text{m}\Omega$
$R_{DS(on),TYP} @ V_{GS}=4.5$ V	42	$\text{m}\Omega$
I_D	4	A

SOT23



Halogen-Free

Part ID	Package Type	Marking	Tape and reel information
VSC045N04MS	SOT23	004	3000pcs/reel



Maximum ratings, at $T_j=25$ °C, unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	40	V
I_s	Diode continuous forward current	$T_c=25^\circ\text{C}$	A
I_D	Continuous drain current@ $V_{GS}=10$ V	$T_c=25^\circ\text{C}$	A
		$T_c=100^\circ\text{C}$	A
I_{DM}	Pulse drain current tested ①	$T_c=25^\circ\text{C}$	A
P_D	Maximum power dissipation	$T_c=25^\circ\text{C}$	W
V_{GS}	Gate-Source voltage	± 20	V
T_{STG}	Storage temperature range	-55 to 175	°C
T_j	Maximum Junction Temperature	150	°C

Thermal Characteristics

Symbol	Parameter	Typical	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	80	°C/W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	100	°C/W

Typical Electrical Characteristics

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$	40	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current($T_c=25^\circ\text{C}$)	$V_{\text{DS}}=32\text{V}$, $V_{\text{GS}}=0\text{V}$	--	0.01	1	μA
	Zero Gate Voltage Drain Current($T_c=125^\circ\text{C}$)	$V_{\text{DS}}=32\text{V}$, $V_{\text{GS}}=0\text{V}$	--	5	100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	--	--	± 100	nA
$V_{\text{GS}(\text{TH})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_D=250\mu\text{A}$	1.0	1.5	2.5	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}$, $I_D=4\text{A}$	--	36	45	$\text{m}\Omega$
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance	$V_{\text{GS}}=4.5\text{V}$, $I_D=2\text{A}$	--	42	50	$\text{m}\Omega$
Dynamic Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)						
C_{iss}	Input Capacitance	$V_{\text{DS}}=20\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	--	345	--	pF
C_{oss}	Output Capacitance		--	43	--	pF
C_{rss}	Reverse Transfer Capacitance		--	18	--	pF
Q_g	Total Gate Charge	$V_{\text{DS}}=20\text{V}$, $I_D=3\text{A}$, $V_{\text{GS}}=10\text{V}$	--	8.6	--	nC
Q_{gs}	Gate-Source Charge		--	1.7	--	nC
Q_{gd}	Gate-Drain Charge		--	2.2	--	nC
Switching Characteristics						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=20\text{V}$, $I_D=1\text{A}$, $R_G=6.8\Omega$, $V_{\text{GS}}=10\text{V}$	--	5.8	--	nS
t_r	Turn-on Rise Time		--	2.8	--	nS
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	16	--	nS
t_f	Turn-Off Fall Time		--	2.2	--	nS
Source- Drain Diode Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)						
I_{SD}	Source-drain current(Body Diode)	$T_c=25^\circ\text{C}$	--	--	4	A
V_{SD}	Forward on voltage	$I_{\text{SD}}=4\text{A}$, $V_{\text{GS}}=0\text{V}$	--	0.79	1.3	V
t_{rr}	Reverse Recovery Time	$T_j=25^\circ\text{C}$, $I_{\text{sd}}=3\text{A}$, $V_{\text{GS}}=0\text{V}$ $dI/dt=100\text{A}/\mu\text{s}$	--	25	--	nS
Q_{rr}	Reverse Recovery Charge		--	28	--	nC

NOTE:

①Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.

Typical Characteristics

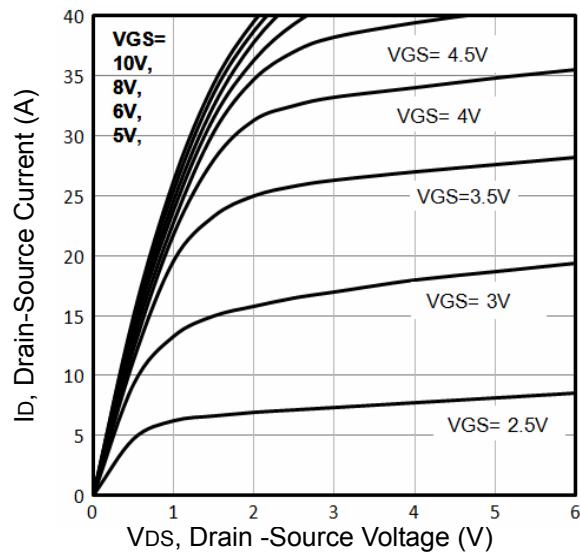


Fig1. Typical Output Characteristics

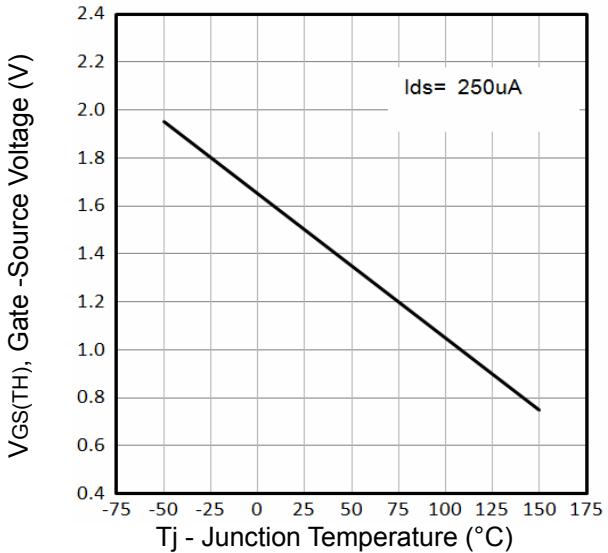


Fig2. Threshold Voltage Vs. Temperature

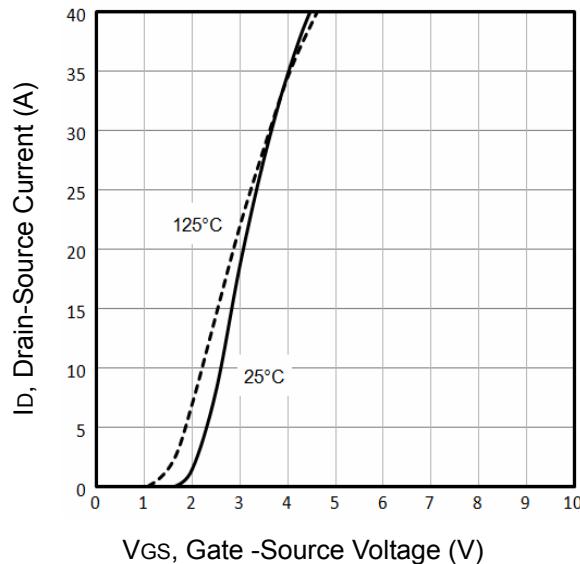


Fig3. Typical Transfer Characteristics

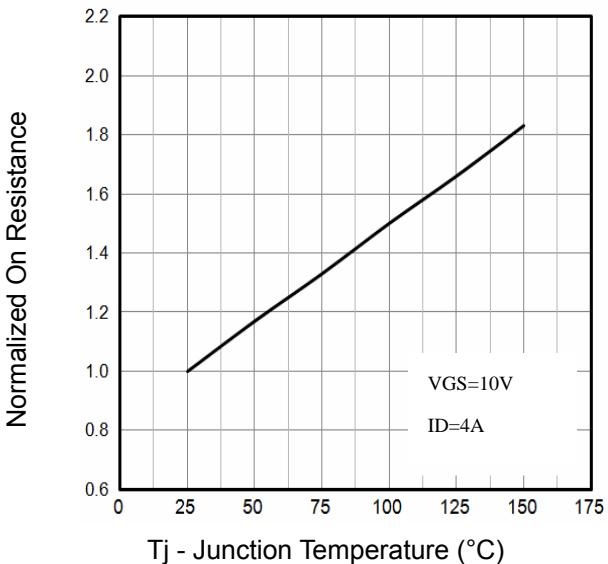


Fig4. Normalized On-Resistance Vs. Temperature

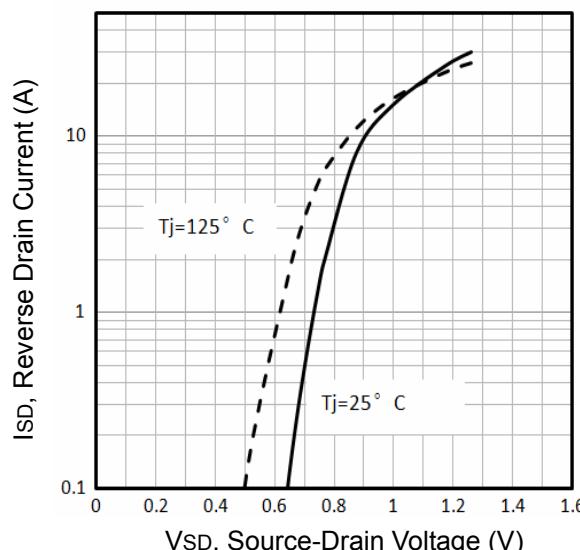


Fig5. Typical Source-Drain Diode Forward Voltage

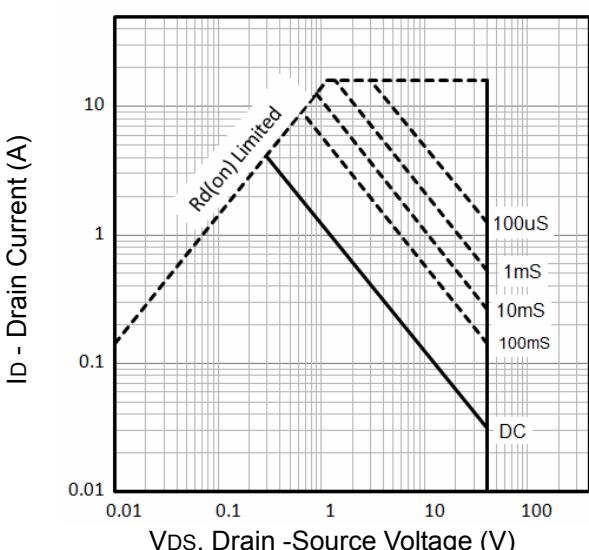


Fig6. Maximum Safe Operating Area

Typical Characteristics

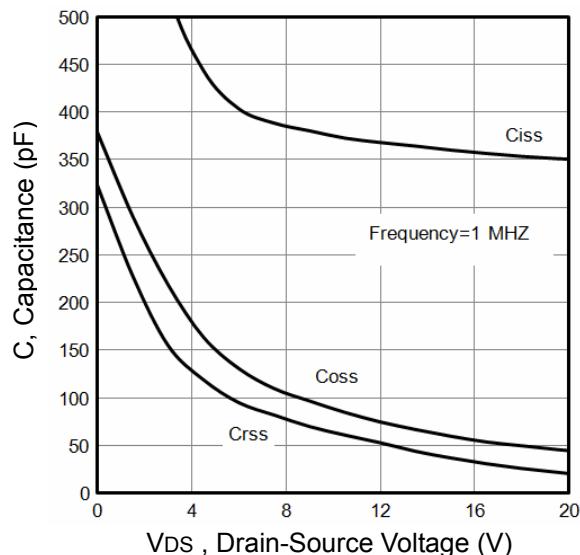


Fig7. Typical Capacitance Vs.Drain-Source Voltage

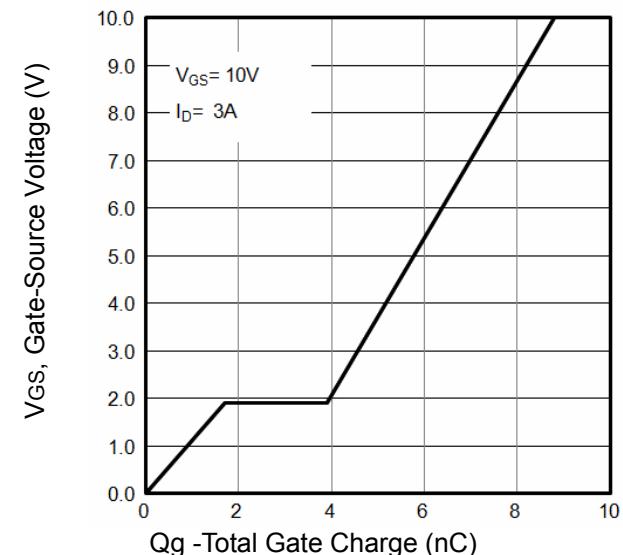
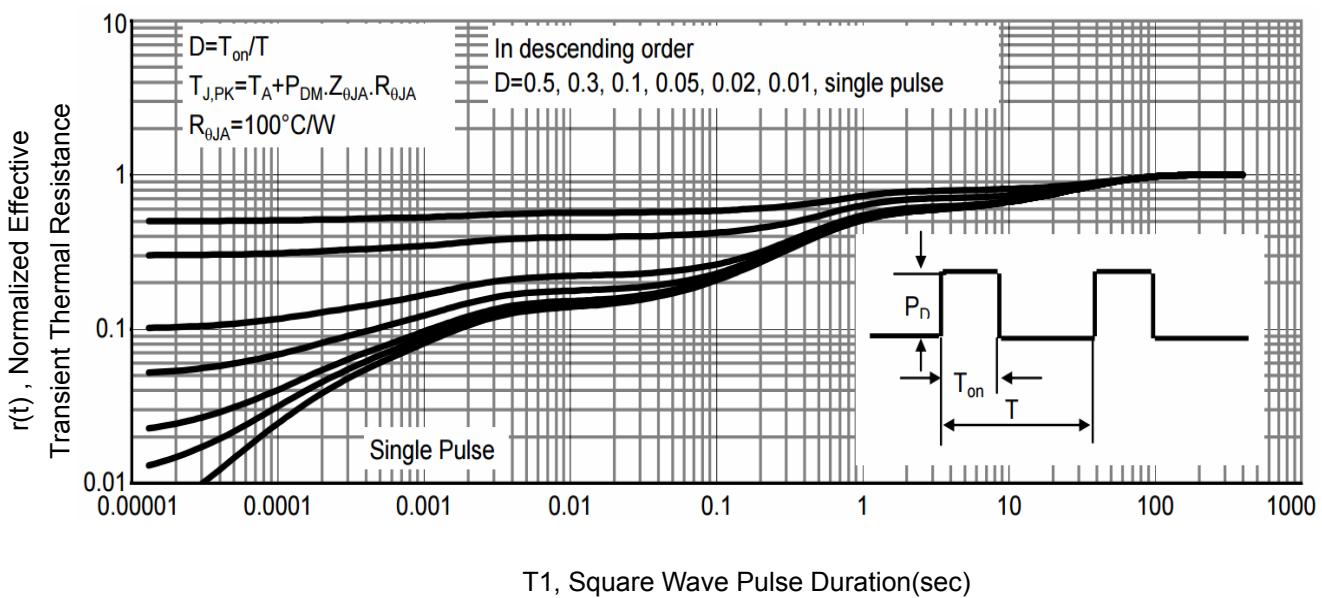


Fig8. Typical Gate Charge Vs.Gate-Source Voltage



T1, Square Wave Pulse Duration(sec)

Fig9. T1 ,Transient Thermal Response Curve

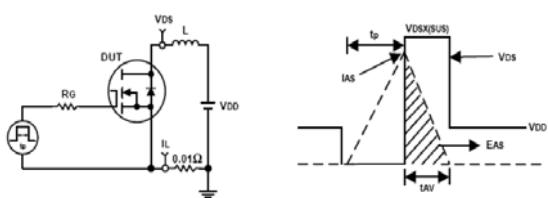


Fig10. Unclamped Inductive Test Circuit and waveforms

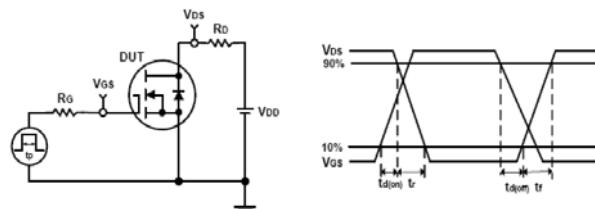
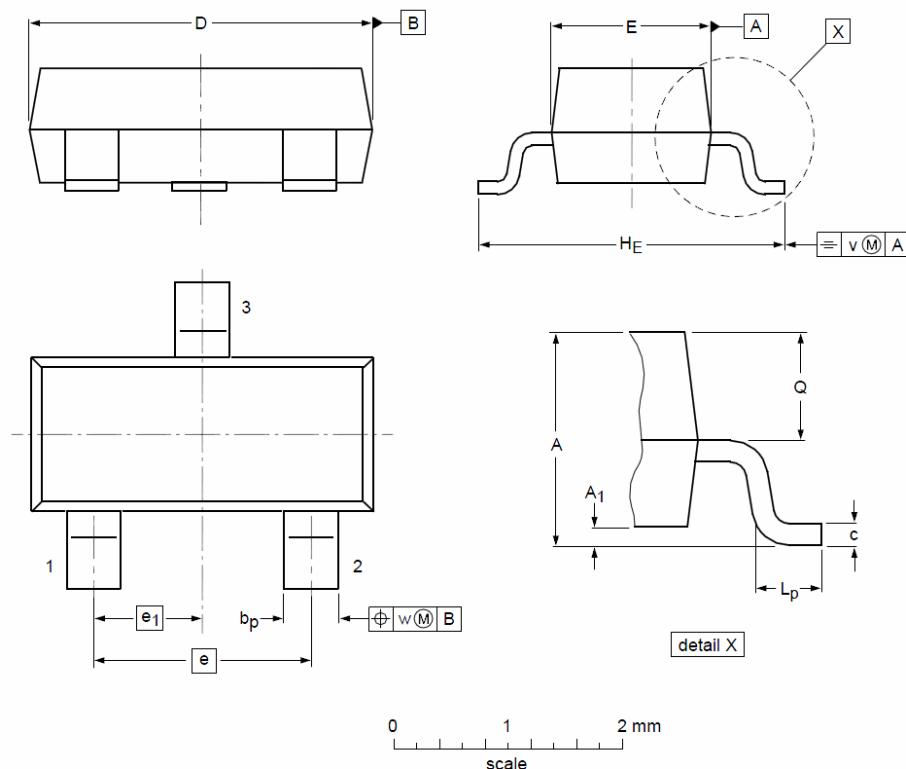


Fig11. Switching Time Test Circuit and waveforms

SOT23 Package Outline Data



DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	0.90	1.03	1.10	A₁	0.01	0.05	0.10
b_p	0.38	0.42	0.48	c	0.09	0.13	0.15
D	2.80	2.92	3.00	E	1.20	1.33	1.40
e	--	1.90	--	e₁	--	0.95	--
H_E	2.10	2.40	2.50	L_p	0.15	0.23	0.45
Q	0.45	0.49	0.55	v	--	0.20	--
w	--	0.10	--				

Customer Service

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